

Fully Printed VO₂ Switch Based Flexible and Reconfigurable Filter

Shuai Yang¹, Weiwei Li, Mohammad Vaseem, Atif Shamim

IMPACT Lab, King Abdullah University of Science and Technology, Thuwal, Saudi Arabia

¹shuai.yang@kaust.edu.sa

Abstract— Frequency reconfigurable filters are high in demand because they can cover multiple frequency bands, thus minimizing system level cost and size requirements. Another emerging trend is the flexibility or conformability of the electronic components, so that they are suitable for mounting on non-planar objects as well as for wearable applications. In this work, we demonstrate a frequency reconfigurable bandpass filter that has been fully printed on a flexible Kapton substrate. The frequency reconfigurability has been achieved through a switch made of Metal Insulator Transition (MIT) material Vanadium-di-oxide (VO₂). The VO₂ switch has been printed through a custom ink. The switch is in OFF condition (insulating condition) at room temperature and turns ON (becomes conductive) at MIT temperature of 68°C. The microstrip bandpass filter employs dual mode resonators and can switch from 4.0 GHz to 3.7 GHz. The required thermal bias is provided through a printed heater which is attached to the backside of the filter. Due to the flexible Kapton substrate and the printing process, the prototype of the filter is highly flexible and low cost. Measured results are promising and in good agreement with the simulation results.

Keywords— VO₂, dual-mode, full printed, MIT, reconfigurable filter.

I. INTRODUCTION

Nowadays, many wireless standards coexist with different operating frequencies. For example, Wi-Fi works at 2.4 GHz and 5 GHz, GSM works at 800-900 MHz and 1800-1900 MHz, etc. Modern wireless devices, such as smartphones, are employing various wireless standards to cater for multiple applications. Filters are integral part of any radio and are typically large in size. Conventional RF filters generally cover a single frequency band, which means a large number of filters are required in a wireless system, increasing the size and cost of the system. Thus, reducing the number or the size of the filters in a wireless system will help in lowering the cost as well as size. Frequency reconfigurable filters, that can change their band of operation on demand, can be a potential solution to this problem. Another emerging trend is wearable wireless devices, which require the electronics to be conformal to the human body so that they are convenient to wear. So flexible and lightweight filters are also very desirable in addition to low cost and compact size.

Most of the above features can be achieved through additive manufacturing. In additive manufacturing such as inkjet printing and screen printing, the material is only deposited where required in a digital fashion, unlike the conventional subtractive methods where the material is deposited everywhere and the pattern is realized through removal (etching) of material. So, there are considerable cost savings. Further cost savings are also possible because

printing does not require a cleanroom environment or expensive vacuum-based processes. Moreover, the printing process is quite compatible with flexible substrates.

Reconfigurable filters based on switches [1]–[4] or varactors [5]–[7] can be found in literature, but none of them is printed. A couple of VO₂ MIT based reconfigurable filters have also been demonstrated but have been realized through expensive and time-consuming cleanroom-based processes such as sputtering [2], [8]. Several additively manufactured filters have also been reported in the literature [9]–[12]. In [9], W-band bandpass filters are presented using the aerosol jet printing process. Whereas in [10], a 12 GHz inkjet printed hairpin bandpass filter has been fabricated on a liquid crystal polymer substrate. Another inkjet printed dual-mode ring bandpass filter has been demonstrated in [11]. In [12], an inkjet printed parallel-coupled microstrip filter has been demonstrated on a flexible Kapton substrate at 85 GHz. It is noticeable that none of the printed filters in the literature show any kind of reconfigurability. This is probably because attaching small switches or diodes to the printed traces is not easy as they cannot sustain conventional soldering [13]. Furthermore, these are rigid surface mount components and thus not flexible. Finally, switches at mm-wave can be very expensive, where a single switch can cost up to 38 dollars [14]. All the above-mentioned issues can be alleviated if the switch can also be printed with the RF component [15].

This work demonstrates a fully printed frequency reconfigurable filter utilizing a Vanadium Dioxide (VO₂) based switch on a flexible substrate. Silver paste has been used for printing the metallic traces as well as the metal ground plane. VO₂ ink has been used to print the RF switch thus there is no requirement of soldering. The filter has been realized through an extremely low-cost printing process. The VO₂ based RF switches in this filter can be activated by applying external heat, which is realized by a printed heater on the backside of the filter. The fabricated filter demonstrates an acceptable insertion loss of around 2.6 dB at the two operating frequencies, i.e. 3.75 GHz and 4 GHz. This is a unique filter that is fully printed as well as frequency reconfigurable and can operate in flat and bent conditions.

II. FILTER DESIGN AND FABRICATION

A. Fully printed VO₂ switch

VO₂ is an MIT material, which exhibits dielectric properties at room temperature or in the absence of bias current. It becomes conductive when the temperature is above the metal transition temperature (68°C in this case) or with the

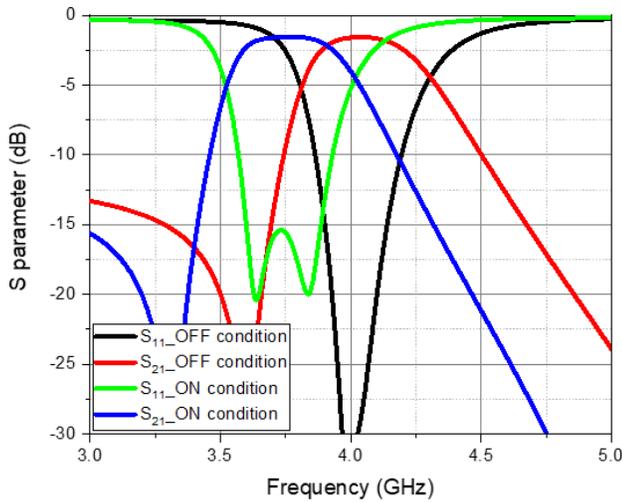


Fig. 3 The simulated S-parameters of the filter design with ideal switches.

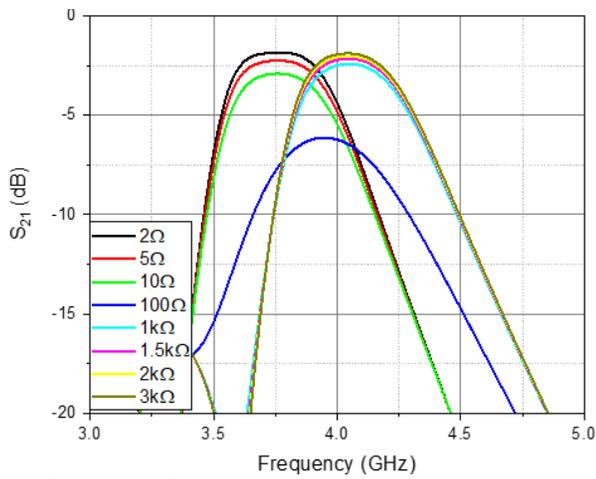


Fig. 4 The simulated S-parameters of the filter as sweeping the resistance of the RF switch (switch length set to 100 μm). Note that only S_{21} curves have been plotted for clarity purposes.

the thickness. The width of each switch will be the same as the width of the metal trace connecting to it, so it is a fixed value. We choose 100 μm for each switch's length to simplify the fabrication process. The resistance of the switches is varied by changing their thicknesses, which in fabrication is just increasing the number of printed layers. The simulated performance of the filter with different VO_2 switch resistance values is shown in Fig. 4. From the figure it can be observed that for the OFF state, a larger resistance value produces lower insertion loss, whereas for ON state, a smaller resistance value provides better performance. Considering an ON/OFF ratio of 300 can be realized for our fully printed VO_2 switch, we choose an ON resistance of 5 Ω and an OFF resistance of 1.5 k Ω as a combination to deliver reasonable and balanced insertion loss at both conditions, i.e. 2.3dB at 3.75GHz and 4GHz.

D. Fabrication Process

The fabrication of the designed filter is done through printing the conductive parts, i.e. the grayish area in Fig. 1, on

a flexible Kapton film (125 μm in thickness) utilizing a commercial silver paste (PE819, DuPont) on a screen printer (AUREL 900PA). After printing, the sample is baked in a vacuum oven at 300 $^\circ\text{C}$ for 1 h. Next, the RF switch is printed at the desired area using the VO_2 nanoparticles-based ink, followed by sintering at 120 $^\circ\text{C}$ for 20 min. A total of 15 passes (110 μm) have been printed in order to achieve the desired ON and OFF resistance mentioned in the previous section. Finally, the ground plane is printed using silver paste. In the last step of the fabrication process, the sample is heated in an oven at 120 $^\circ\text{C}$ for 10 min. The fabricated sample is shown in Fig. 5, which is quite flexible, as is evident from the figure.

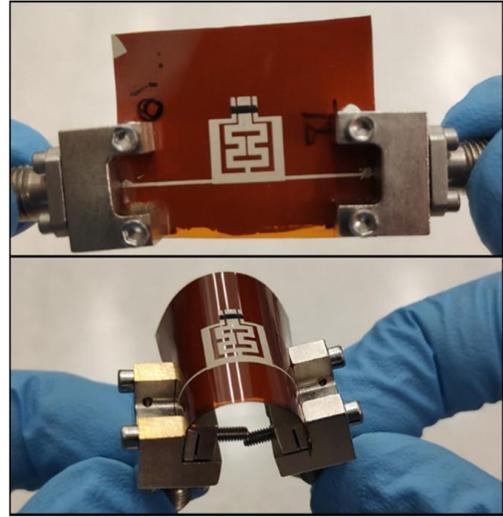


Fig.5 Picture of the fabricated sample at flat and bending conditions

III. MEASUREMENT RESULTS AND DISCUSSION

The fabricated sample has been characterized via a calibrated Vector Network Analyzer (VNA) from 2.5 GHz to 5.5 GHz. The measured and simulated results are plotted in Fig. 6, where the dashed curves represent the simulation

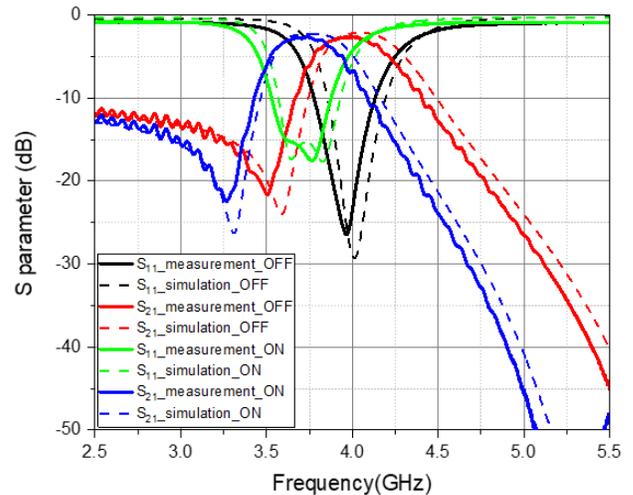


Fig. 6 The simulation and measurement results of the filter at both ON and OFF conditions.

results, and solid curves indicate the measurement results. As can be seen from the figure, for both the ON and OFF conditions, the measured results match well with the simulated results, except for a minor 50 MHz frequency downward shift for the measured values. This is probably due to the fact that the printed lines are slightly wider than the designed ones due to the ink spreading in the screen-printing process. The measured insertion losses at both ON and OFF conditions are 2.6 dB, which is slightly higher than the simulated value of 2.3 dB.

IV. CONCLUSION

In this work, a fully printed, frequency reconfigurable filter based on VO₂ RF switch has been demonstrated which is small in size due to the dual mode resonator as well as meandering of lines. The frequency reconfigurable filter operates at 4 GHz and 3.75 GHz in the OFF and ON state of the VO₂ switch respectively, through thermal excitation by a printed coil at the backside of the filter. The simulated and measured results are in good agreement. An insertion loss of 2.6 dB has been measured for both bands, which is decent provided the relatively low conductivity of the silver ink used in the process. This performance of the fully printed filter, which is quite flexible as well, is comparable to other reconfigurable filter works realized through the conventional fabrication processes, which can be expensive as well as time-consuming.

REFERENCES

- [1] P. Vryonides, S. Nikolaou, S. Kim, and M. M. Tentzeris, "Reconfigurable dual-mode band-pass filter with switchable bandwidth using PIN diodes," *Int. J. Microw. Wirel. Technol.*, vol. 7, no. 6, pp. 655–660, Dec. 2015.
- [2] E. A. Casu *et al.*, "Vanadium Oxide Bandstop Tunable Filter for Ka Frequency Bands Based on a Novel Reconfigurable Spiral Shape Defected Ground Plane CPW," *IEEE Access*, vol. 6, pp. 12206–12212, 2018.
- [3] D. Bouyge *et al.*, "Reconfigurable 4 pole bandstop filter based on RF-MEMS-loaded split ring resonators," in *2010 IEEE MTT-S International Microwave Symposium*, 2010, pp. 588–591.
- [4] A. Contreras, J. Casals-Terré, L. Pradell, F. Giacomozzi, J. Iannacci, and M. Ribó, "Reconfigurable multimodal bandpass filter based on RF-MEMS switchable CPW air-bridges," in *2013 European Microwave Integrated Circuit Conference*, 2013, pp. 328–331.
- [5] A. Ebrahimi, T. Baum, J. Scott, and K. Ghorbani, "Continuously Tunable Dual-Mode Bandstop Filter," *IEEE Microw. Wirel. Compon. Lett.*, vol. 28, no. 5, pp. 419–421, May 2018.
- [6] R. Gómez-García and A. C. Guyette, "Reconfigurable Multi-Band Microwave Filters," *IEEE Trans. Microw. Theory Tech.*, vol. 63, no. 4, pp. 1294–1307, Apr. 2015.
- [7] S. Jeong, T. Lee, and J. Lee, "Frequency- and Bandwidth-Tunable Absorptive Bandpass Filter," *IEEE Trans. Microw. Theory Tech.*, vol. 67, no. 6, pp. 2172–2180, Jun. 2019.
- [8] D. Bouyge *et al.*, "Applications of vanadium dioxide (VO₂)-loaded electrically small resonators in the design of tunable filters," in *The 40th European Microwave Conference*, 2010, pp. 822–825.
- [9] M. T. Craton, J. Sorocki, I. Piekarczyk, S. Gruszczynski, K. Wincza, and J. Papapolymerou, "Realization of Fully 3D Printed W-Band Bandpass Filters Using Aerosol Jet Printing Technology," in *2018 48th European Microwave Conference (EuMC)*, 2018, pp. 1013–1016.
- [10] H.-L. Kao and C.-L. Cho, "Fully Inkjet-Printed Three-Dimensional Bandpass Filter on Liquid Crystal Polymer Substrate," in *2018 IEEE 68th Electronic Components and Technology Conference (ECTC)*, 2018, pp. 2218–2222.
- [11] C.-L. Cho, H.-L. Kao, Y.-H. Wu, H.-C. Chiu, and L.-C. Chang, "Fully Inkjet-Printed Dual-Mode Ring Bandpass Filter Using a Cross-Bridge Structure Embedded With a Metal–Insulator–Metal Capacitor," *IEEE Trans. Compon. Packag. Manuf. Technol.*, vol. 8, no. 10, pp. 1869–1875, Oct. 2018.
- [12] S. Yang, S. Zhen, and A. Shamim, "Fully Inkjet Printed 85GHz Band Pass Filter on Flexible Substrate," in *2018 48th European Microwave Conference (EuMC)*, 2018, pp. 652–654.
- [13] M. F. Farooqui, C. Claudel, and A. Shamim, "An Inkjet-Printed Buoyant 3-D Lagrangian Sensor for Real-Time Flood Monitoring," *IEEE Trans. Antennas Propag.*, vol. 62, no. 6, pp. 3354–3359, Jun. 2014.
- [14] "HMC1084LC4 Analog Devices Inc. | RF/IF and RFID | DigiKey." [Online]. Available: <https://www.digikey.com/product-detail/en/analog-devices-inc/HMC1084LC4/1127-1673-ND/4476105>. [Accessed: 01-Dec-2019].
- [15] S. Yang, M. Vaseem, and A. Shamim, "Fully Inkjet-Printed VO₂-Based Radio-Frequency Switches for Flexible Reconfigurable Components," *Adv. Mater. Technol.*, vol. 4, no. 1, p. 1800276, 2019.